L Number	Hits	Search Text	DB	Time stamp
-	1362	(257/777).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 11:47
-	1351	257/777.ccls. and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 11:49
-	51	257/777.ccls. and (chamfer$6 or bevel$6 or obliq$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 12:04
-	950	257/777.ccls. and @ad<=20040326	USPAT	2004/11/12 11:49
-	51	257/777.ccls. and (chamfer$6 or bevel$6 or obliq$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 11:49
-	7881	257/$.ccls. and (chamfer$6 or bevel$6 or obliq$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 12:05
-	0	(257/$.ccls. with ((first and second) adj (chip or die))) and (chamfer$6 or bevel$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 12:07
-	0	(257/$.ccls. with ((first adj (chip or die)) and (second adj (chip or die)))) and (chamfer$6 or bevel$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 12:08
-	0	(438/$.ccls. with ((first adj (chip or die)) and (second adj (chip or die)))) and (chamfer$6 or bevel$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 12:08
-	3	(semiconductor with ((first adj (chip or die)) and (second adj (chip or die)))) and (chamfer$6 or bevel$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 12:09
-	2870	257/$.ccls. and (chamfer$6 or bevel$6) and @ad<=20040326	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/12 12:11